

## **Ultra Precision Thin Film MELF Resistors**



UMA 0204 and UMB 0207 ultra precision thin film MELF resistors combine the proven reliability of precision MELF products with the most advanced level of precision and stability first achieved with axial thin film precision resistors. This unique combination makes the product perfectly suited for all applications with outstanding requirements towards reliable precision and stability.

#### **FEATURES**

- Most advanced thin film technology
- Long term stability down to 0.02 %
- TCR down to ± 5 ppm/K
- High precision tolerance down to ± 0.02 %
- Operating voltage 350 V for UMB 0207
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>



(5-2008)

#### **APPLICATIONS**

- · Measuring and calibration equipment
- · Industrial process control systems
- Space and aircraft electronics
- · Medical equipment

TECHNICAL SPECIFICATIONS			
DESCRIPTION	UMA 0204	UMB 0207	
DIN size	0204	0207	
Metric size code	RC3715M	RC6123M	
Resistance range	22 $\Omega$ to 332 k $\Omega$	100 Ω to 390 kΩ	
Resistance tolerance	± 0.25 %; ± 0.1 %; ± 0.05 %; ± 0.02 %		
Temperature coefficient	± 15 ppm/K; ± 10 ppm/K; ± 5 ppm/K		
Rated dissipation, $P_{70}^{(1)}$	0.25 W	0.4 W	
Operating voltage, $U_{\rm max.}$ AC <sub>RMS</sub> /DC	200 V 350 V		
Permissible film temperature, $\vartheta_{\max}$ (1)	125	5°C	
Operating temperature range (1)	-55 °C to 125 °C		
Permissible voltage against ambient (insulation):			
1 min; <i>U</i> <sub>ins</sub>	300 V	500 V	
Failure rate: FIT <sub>observed</sub>	≤ 0.05 ≥	κ 10 <sup>–9</sup> /h	

#### Note

### **APPLICATION INFORMATION**

When the resistor dissipates power, a temperature rise above the ambient temperature occurs, dependent on the thermal resistance of the assembled resistor together with the printed circuit board. The rated dissipation applies only if the permitted film temperature is not exceeded.

These resistors do not feature a limited lifetime when operated within the permissible limits. However, resistance value drift increasing over operating time may result in exceeding a limit acceptable to the specific application, thereby establishing a functional lifetime.

<sup>(1)</sup> Please refer to APPLICATION INFORMATION below



MAXIMUM RESISTANCE CHANGE AT RATED DISSIPATION						
OPERATION MODE		PRECISION	STANDARD			
Rated dissipation, P <sub>70</sub>	UMA 0204	0.07 W	0.25 W			
nated dissipation, F70	UMB 0207	0.11 W	0.4 W			
Operating temperature range		-55 °C to 85 °C	-55 °C to 125 °C			
Permissible film temperature, $\vartheta_{\text{F}}$ ma	ax.	85 °C	125 °C			
	UMA 0204	22 $\Omega$ to 332 k $\Omega$	22 $\Omega$ to 332 k $\Omega$			
	UMB 0207	100 $\Omega$ to 390 k $\Omega$	100 $\Omega$ to 390 k $\Omega$			
Max. resistance change at $P_{70}$ for resistance range, $ \Delta R/R $ after:	1000 h	≤ 0.02 %	≤ 0.05 %			
	8000 h	≤ 0.05 %	≤ 0.1 %			
	225 000 h	≤ 0.15 %	≤ 0.3 %			

	COEFFICIENT AND R				
TYPE / SIZE	TCR	TOLERANCE	RESISTANCE	E-SERIES	
	± 15 ppm/K	± 0.05 %	47 $\Omega$ to 332 k $\Omega$		
		± 0.25 %	22 $\Omega$ to 332 k $\Omega$		
	± 10 ppm/K	± 0.1 %	43 $\Omega$ to 332 k $\Omega$		
UMA 0204		± 0.05 %	75 $\Omega$ to 221 k $\Omega$		
UMA UZU4		± 0.25 %	33 Ω to 221 kΩ		
	± 5 ppm/K	± 0.1 %	56 Ω to 221 kΩ		
		± 0.05 %	75 Ω to 150 kΩ		
		± 0.02 %	75 Ω to 100 kΩ	E04: E100	
	± 15 ppm/K	± 0.05 %	100 Ω to 390 kΩ	E24; E192	
		± 0.25 %	100 Ω to 390 kΩ		
	± 10 ppm/K	± 0.1 %	100 Ω to 390 kΩ		
UMB 0207		± 0.05 %	100 Ω to 390 kΩ		
		± 0.25 %	270 Ω to 390 kΩ		
	. E nam//	± 0.1 %	270 Ω to 390 kΩ		
	± 5 ppm/K	± 0.05 %	270 Ω to 390 kΩ		
		± 0.02 %	270 Ω to 390 kΩ		

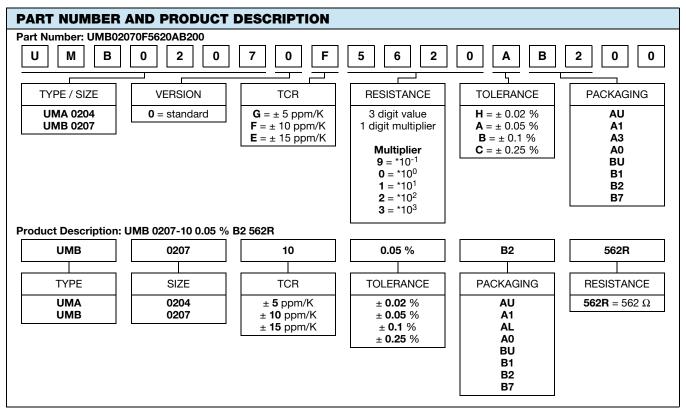
<sup>(1)</sup> For the approved IECQ-CECC resistance range, please refer to <a href="https://www.vishay.com/doc?28945">www.vishay.com/doc?28945</a>

PACKAGING						
TYPE / SIZE	CODE	QUANTITY	PACKAGING STYLE	WIDTH	PITCH	PACKAGING DIMENSIONS
UMA 0204	AU	100			4 mm	Box
	A1	1000	Antistatic blister tape acc.	8 mm		Ø 180 mm / 7"
	A3 = AL	3000	IEC 60286-3, Type 2a	0 111111		Ø 160 IIII17 7
	A0	10 000				Ø 330 mm / 13"
UMB 0207	BU	100				Box
	B1	1000	Antistatic blister tape acc.	12 mm	4 mm	Ø 180 mm / 7"
	B2	2000	IEC 60286-3, Type 2a	12 111111	4 1/1/11	100 IIIII / I
	B7	7000				Ø 330 mm / 13"



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#### Note

• Products can be ordered using either the PART NUMBER or the PRODUCT DESCRIPTION



### **DESCRIPTION**

Production is strictly controlled and follows an extensive set of instructions established for reproducibility. A homogeneous film of special metal alloy is deposited on a high grade ceramic body (Al<sub>2</sub>O<sub>3</sub>) and conditioned to achieve the desired temperature coefficient. Nickel plated steel termination caps are firmly pressed on the metallized rods. A special laser is used to achieve the target value by smoothly cutting a helical groove in the resistive layer without damaging the ceramics. The resistor elements are covered by a unique protective coating designed for electrical, mechanical, and climatic protection. The terminations receive a final pure matte tin on nickel plating. Five color code rings designate the resistance value and tolerance in accordance with **IEC 60062** <sup>(1)</sup>.

The result of the determined production is verified by an extensive testing procedure and optical inspection performed on 100 % of the individual resistors. This includes full screening for the elimination of products with a potential risk of early field failures. Only accepted products are laid directly into the blister tape in accordance with **IEC 60286-3, Type 2a** <sup>(1)</sup>.

### **ASSEMBLY**

The resistors are suitable for processing on automatic SMD assembly systems. They are suitable for automatic soldering using wave, reflow or vapor phase as shown in **IEC 61760-1** <sup>(1)</sup>. The encapsulation is resistant to all cleaning solvents commonly used in the electronics industry, including alcohols, esters and aqueous solutions. The suitability of conformal coatings, potting compounds and their processes, if applied, shall be qualified by appropriate means to ensure the long term stability of the whole system.

The resistors are completely lead (Pb)-free, the pure matte tin plating provides compatibility with lead (Pb)-free and lead containing soldering processes. Solderability is specified for 2 years after production or requalification, however, excellent solderability is proven after extended storage in excess of 10 years. The permitted storage time is 20 years. The immunity of the plating against tin whisker growth has been proven under extensive testing.

#### **MATERIALS**

Vishay acknowledges the following systems for the regulation of hazardous substances:

- IEC 62474, Material Declaration for Products of and for the Electrotechnical Industry, with the list of declarable substances given therein (2)
- The Global Automotive Declarable Substance List (GADSL) (3)
- The REACH regulation (1907/2006/EC) and the related list of substances with very high concern (SVHC) (4) for its supply chain

The products do not contain any of the banned substances as per IEC 62474, GADSL, or the SVHC list, see <a href="https://www.vishay.com/how/leadfree">www.vishay.com/how/leadfree</a>.

Hence the products fully comply with the following directives:

- 2000/53/EC End-of-Life Vehicle Directive (ELV) and Annex II (ELV II)
- 2011/65/EU Restriction of the Use of Hazardous Substances Directive (RoHS) with amendment 2015/863/EU
- 2012/19/EU Waste Electrical and Electronic Equipment Directive (WEEE)

Vishay pursues the elimination of conflict minerals from its supply chain, see the Conflict Minerals Policy at www.vishay.com/doc?49037.

#### **APPROVALS**

Where applicable the resistors are approved within the IECQ-CECC Quality Assessment System for Electronic Components to the detail specification **EN 140401-803** which refers to **EN 60115-1, EN 60115-8** and the variety of environmental test procedures of the **IEC 60068** <sup>(1)</sup> series.

Conformity is attested by the use of the **CECC** logo (**a**) as the mark of conformity on the package label.

Vishay Beyschlag has achieved "Approval of Manufacturer" in accordance with IECQ 03-1. The release certificate for "Technology Approval Schedule" in accordance with CECC 240001 based on IECQ 03-3-1 is granted for the Vishay Beyschlag manufacturing process.

### **RELATED PRODUCTS**

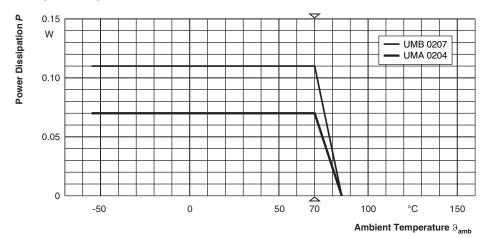
For products with a wider range of TCR, tolerance and resistance, see the datasheets:

- "Professional Thin Film MELF Resistors" (www.vishay.com/doc?28713)
- "Precision Thin Film MELF Resistors" (www.vishay.com/doc?28714)

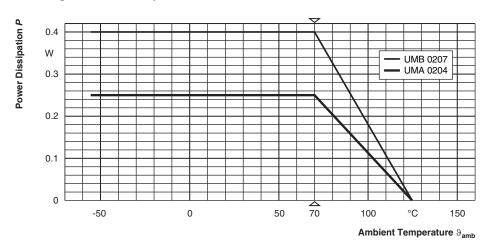
- (1) The quoted IEC standards are also released as EN standards with the same number and identical contents
- (2) The IEC 62474 list of declarable substances is maintained in a dedicated database, which is available at http://std.iec.ch/iec62474.
- (3) The Global Automotive Declarable Substance List (GADSL) is maintained by the American Chemistry Council and available at <a href="https://www.gadsl.org">www.gadsl.org</a>
- (4) The SVHC list is maintained by the European Chemical Agency (ECHA) and available at http://echa.europa.eu/candidate-list-table



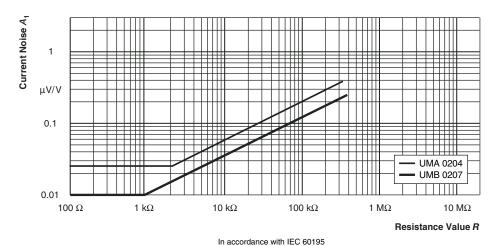
## **FUNCTIONAL PERFORMANCE**



## **Derating - Precision Operation Mode**



## **Derating - Standard Operation Mode**



**Current Noise - A<sub>1</sub>** 



## **TESTS AND REQUIREMENTS**

All tests are carried out in accordance with the following specifications:

EN 60115-1, generic specification

EN 60115-8, sectional specification

EN 140401-803, detail specification

IEC 60068-2-xx, test methods

The components are approved under the IECQ-CECC quality assessment system for electronic components according to table "Temperature Coefficient and Resistance Range".

The parameters stated in the Test Procedures and Requirements table are based on the required tests and permitted limits of EN 140401-803. The table presents only the most important tests, for the full test schedule refer to the documents listed above. However, some additional tests and a number of improvements against those minimum requirements have been included.

The testing also covers most of the requirements specified by EIA/ECA-703 and JIS-C-5201-1.

The tests are carried out under standard atmospheric conditions in accordance with IEC 60068-1, 4.3, whereupon the following values are applied:

Temperature: 15 °C to 35 °C Relative humidity: 25 % to 75 %

Air pressure: 86 kPa to 106 kPa (860 mbar to 1060 mbar) A climatic category LCT / UCT / 56 is applied, defined by the lower category temperature (LCT), the upper category temperature (UCT), and the duration of exposure in the damp heat, steady state test (56 days).

The components are mounted for testing on printed circuit boards in accordance with EN 60115-8, 2.4.2, unless otherwise specified.

TEST	TEST PROCEDURES AND REQUIREMENTS							
EN 60115-1 CLAUSE	IEC 60068-2 <sup>(1)</sup> TEST METHOD	TEST	PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE (△R)				
			Stability for product types:	STABILITY CLASS 0.05 OR BETTER	STABILITY CLASS 0.1 OR BETTER	STABILITY CLASS 0.25 OR BETTER		
			UMA 0204	100 $\Omega$ to 100 k $\Omega$	43 $\Omega$ to 221 k $\Omega$	22 $\Omega$ to 332 k $\Omega$		
			UMB 0207	270 $\Omega$ to 100 k $\Omega$	100 $\Omega$ to 390 k $\Omega$	-		
4.5	-	Resistance	-	± 0.25 % R;	± 0.1 % R; ± 0.05 % R	?; ± 0.02 % R		
4.8		Temperature	At (20/-10/20) °C and (20/85/20) °C	=	± 10 ppm/K; ± 5 ppm/k	<		
4.0	-	coefficient	At (20/-55/20) °C and (20/125/20) °C		± 15 ppm/K			
		Endurance at 70 °C:	$U = \sqrt{P_{70} \times R}$ or $U = U_{\text{max}}$ ; whichever is the less severe; 1.5 h on; 0.5 h off;					
		Precision operation mode	70 °C; 1000 h		$\pm (0.02 \% R + 1 \text{ m}\Omega)$			
4.05.4		operation mode	70 °C; 8000 h	± (0.05 % R + 1 mΩ)				
4.25.1	-	Endurance at 70 °C:	$U = \sqrt{P_{70} \times R}$ or $U = U_{\text{max.}}$ ; whichever is the less severe; 1.5 h on; 0.5 h off;					
		Standard operation mode	70 °C; 1000 h		$\pm$ (0.05 % $R$ + 1 m $\Omega$ )			
		operation mode	70 °C; 8000 h		± (0.1 % R + 1 mΩ)			
		Endurance at	85 °C; 1000 h	± (0.01 % R + 1 mΩ)	± (0.05 % R + 1 mΩ)	± (0.1 % R + 1 mΩ)		
4.25.3	-	upper category temperature	125 °C; 1000 h	± (0.05 % R + 1 mΩ)	± (0.1 % R + 1 mΩ)	± (0.15 % R + 1 mΩ)		
4.24	78 (Cab)	Damp heat, steady state	(40 ± 2) °C; 56 days; (93 ± 3) % RH	$\pm (0.03 \% R + 1 \text{ m}\Omega) \pm (0.05 \% R + 1 \text{ m}\Omega) \pm (0.1 \% R +$		± (0.1 % R + 1 mΩ)		
4.37	67 (Cy)	Damp heat, steady state, accelerated	$(85 \pm 2)$ °C; $(85 \pm 5)$ % RH; $U = 0.3 \times \sqrt{P_{70}} \times R$ $\leq 100 \text{ V and}$ $U = 0.3 \times U_{\text{max}}$ ; (the smaller value is valid) 1000  h	± (0.1 % R + 1 mΩ)	$\pm (0.25 \% R + 1 mΩ)$ $\pm (0.25 \% R + 1 mΩ)$			



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TEST	PROCEDU	JRES AND RE	QUIREMENTS				
EN 60115-1 CLAUSE	IEC 60068-2 <sup>(1)</sup> TEST METHOD	TEST	PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE (△ <i>R</i> )			
			Stability for product types:	STABILITY CLASS 0.05 OR BETTER	STABILITY CLASS 0.1 OR BETTER	STABILITY CLASS 0.25 OR BETTER	
			UMA 0204	100 Ω to 100 kΩ	43 Ω to 221 kΩ	22 Ω to 332 kΩ	
			UMB 0207	270 Ω to 100 kΩ	100 Ω to 390 kΩ	-	
4.23		Climatic sequence:					
4.23.2	2 (Bb)	Dry heat	UCT; 16 h				
4.23.3	30 (Db)	Damp heat, cyclic	55 °C; 24 h; ≥ 90 % RH; 1 cycle				
4.23.4	1 (Ab)	Cold	LCT; 2 h				
4.23.5	13 (M)	Low air pressure	8.5 kPa; 2 h; (25 ± 10) °C				
4.23.6	30 (Db)	Damp heat, cyclic	55 °C; 24 h; ≥ 90 % RH; 5 cycles				
4.23.7	-	DC load	$U = \sqrt{P_{70} \times R} \le U_{\text{max.}};$ 1 min.	$J = \sqrt{P_{70} \times R} \le U_{\text{max}};$ 1 min.			
			LCT = -10 °C; UCT = 85 °C	± (0.03 % R + 1 mΩ)	± (0.05 % R + 1 mΩ)	-	
			LCT = -55 °C; UCT = 125 °C	-	-	± (0.1 % R + 1 mΩ)	
-	1 (Aa)	Cold	-55 °C; 2 h		± (0.02 % R + 0.1 mΩ)		
			30 min at LCT; 30 min at UCT; LCT = -10 °C; UCT = 85 °C				
		Danid abanga	5 cycles	± (0.01 % R + 1 mΩ)	± (0.02 % R + 1 mΩ)	-	
4.19	14 (Na)	Rapid change of temperature	1000 cycles	± (0.05 % R + 1 mΩ)	$\pm (0.05 \% R + 1 \text{ m}\Omega)$	-	
			LCT = -55 °C; UCT = 125 °C				
			5 cycles	-	-	± (0.025 % R + 1 mΩ)	
			1000 cycles	-	-	± (0.1 % R + 1 mΩ)	
4.12		Short time overload; Precision operation mode	$U = 2.5 \times \sqrt{P_{70} \times R} \text{ or } U = 2 \times U_{\text{max.}};$	$\pm (0.005 \% R + 1 m\Omega)$	± (0.01 %	$R$ + 1 m $\Omega$ )	
4.13	-	Short time overload; Standard operation mode	whichever is the less severe; 5 s	± (0.01 % R + 1 mΩ)			
4.27	-	Single pulse high voltage overload; Standard operation mode	Severity no. 4: $U = 10 \times \sqrt{P_{70}} \times R$ or $U = 2 \times U_{\text{max}}$ ; whichever is the less severe; 10 pulses 10 $\mu$ s/700 $\mu$ s		± (0.25 % R + 5 mΩ)		
4.39	-	Periodic electric overload; Standard operation mode	$U = \sqrt{15 \times P_{70} \times R} \text{ or }$ $U = 2 \times U_{\text{max}};$ whichever is the less severe; $0.1 \text{ s on; } 2.5 \text{ s off;}$ $1000 \text{ cycles}$	± (0.5 % R + 5 mΩ)			



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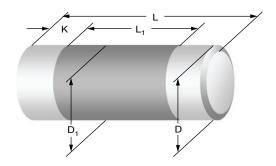
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TEST	TEST PROCEDURES AND REQUIREMENTS								
EN 60115-1 CLAUSE	IEC 60068-2 <sup>(1)</sup> TEST METHOD	TEST	PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE (△R)					
			Stability for product types:	STABILITY CLASS 0.05 OR BETTER	STABILITY CLASS 0.1 OR BETTER	STABILITY CLASS 0.25 OR BETTER			
			UMA 0204	100 $\Omega$ to 100 k $\Omega$	43 $\Omega$ to 221 k $\Omega$	22 $\Omega$ to 332 k $\Omega$			
			UMB 0207	270 $\Omega$ to 100 k $\Omega$	100 $\Omega$ to 390 k $\Omega$	-			
4.22	6 (Fc)	Vibration	Endurance by sweeping; 10 Hz to 2000 Hz; no resonance; amplitude ≤1.5 mm or ≤200 m/s²; 7.5 h	± (0.01 % R + 1 mΩ)					
4.38	-	Electrostatic discharge (Human Body Model)	IEC 61340-3-1 <sup>(1)</sup> ; 3 pos. + 3 neg. discharges UMA 0204: 2 kV UMB 0207: 4 kV	± (0.5 % R + 50 mΩ)					
			Solder bath method; SnPb40; non-activated flux; $(215 \pm 3)$ °C; $(3 \pm 0.3)$ s	Good tinning (≥ 95 % covered); no visible damage					
4.17	58 (Td)	Solderability	Solder bath method; SnAg3Cu0.5 or SnAg3.5; non-activated flux; (235 ± 3) °C; (2 ± 0.2) s	Good tinning (≥ 95 % covered); no visible damage					
		Posistanos to	Solder bath method; (260 ± 5) °C; (2 ± 0.2) s	(2	2)	± (0.05 % R + 10 mΩ)			
4.18	58 (Td)	Resistance to soldering heat	Reflow method 2 (IR/forced gas convection); (260 ± 5) °C; (10 ± 1) s	± (0.01 % R + 1 mΩ)	± (0.02 %	<i>R</i> + 1 mΩ)			
4.29	45 (XA)	Component solvent resistance	Isopropyl alcohol; 50 °C; method 2	No visible damage					
4.30	45 (XA)	Solvent resistance of marking	Isopropyl alcohol; 50 °C; method 1, toothbrush	Marking legible; no visible damage					
4.32	21 (Ue <sub>3</sub> )	Shear (adhesion)	45 N	No visible damage					
4.33	21 (Ue <sub>1</sub> )	Substrate bending	Depth 2 mm, 3 times	No visible damage, no open circuit in bent position $\pm (0.02 \% R + 10 \text{ m}\Omega)$ $\pm (0.05 \% R + 10 \text{ m}\Omega)$		the bent position $\pm (0.05 \% R + 10 \text{ m}\Omega)$			
4.7	-	Voltage proof	$U_{\rm RMS} = U_{\rm ins}$ ; 60 s	No flashover or breakdown					
4.35	-	Flammability	IEC 60695-11-5 <sup>(1)</sup> , needle flame test; 10 s		No burning after 30 s				

<sup>(1)</sup> The quoted IEC standards are also released as EN standards with the same number and identical contents

<sup>(2)</sup> Wave soldering is not recommended

### **DIMENSIONS**

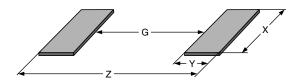


DIMENSIONS AND MASS								
TYPE / SIZE	L (mm)	D (mm)	L <sub>1 min.</sub> (mm)	D <sub>1</sub> (mm)	K (mm)	MASS (mg)		
UMA 0204	3.6 + 0/- 0.2	1.4 + 0/- 0.1	1.8	D + 0/- 0.15	0.75 ± 0.1	22		
UMB 0207	5.8 + 0/- 0.15	2.2 + 0/- 0.2	3.2	D + 0/- 0.2	1.15 ± 0.1	80		

#### Note

Color code marking is applied according to IEC 60062 in five bands. Each color band appears as a single solid line, voids are permissible if at least <sup>2</sup>/<sub>3</sub> of the band is visible from each radial angle of view. The last color band for tolerance is approximately 50 % wider than the other bands. An interrupted band between the 4<sup>th</sup> and 5<sup>th</sup> full band indicates the temperature coefficient (orange = TCR 15 ppm/K, blue = TCR 10 ppm/K, violet = TCR 05 ppm/K)

## **PATTERN STYLES FOR MELF RESISTORS**



RECOMMENDED SOLDER PAD DIMENSIONS								
	WAVE SOLDERING (1) REFLOW SOLDERING							
TYPE / SIZE	G (mm)	Y (mm)	X (mm)	Z (mm)	G (mm)	Y (mm)	X (mm)	Z (mm)
UMA 0204	1.5	1.5	1.8	4.5	1.7	1.2	1.6	4.1
UMB 0207	2.8	2.1	2.6	7.0	3.2	1.7	2.4	6.6

- The given solder pad dimensions reflect the considerations for board design and assembly as outlined e.g. in standards IEC 61188-5-x <sup>(1)</sup>, or in publication IPC-7351
- (1) The quoted IEC standards are also released as EN standards with the same number and identical contents



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